

Electronic Patent Application Fee Transmittal

Application Number:	10680325				
Filing Date:	06-Oct-2003				
Title of Invention:	Apparatus to improve wafer temperature uniformity for face-up wet processing				
First Named Inventor:	Ian A. Pancham				
Filer:	Keith Patrick Taboada				
Attorney Docket Number:	AMAT/8024/CMP/ECP/RKK				
Filed as Large Entity					
Utility Filing Fees					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:					
Pages:					
Claims:					
Miscellaneous-Filing:					
Petition:					
Patent-Appeals-and-Interference:					
Post-Allowance-and-Post-Issuance:					
Extension-of-Time:					
Extension - 1 month with \$0 paid		1251	1	120	120

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				120